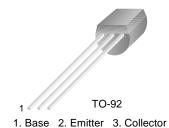


## KSP17

## **CATV Transistor**



# **NPN Epitaxial Silicon Transistor**

# **Absolute Maximum Ratings** $T_a$ =25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	20	V
V <sub>CEO</sub>	Collector-Emitter Voltage 15		V
V <sub>EBO</sub>	Emitter-Base Voltage	3.0	V
P <sub>C</sub>	Collector Dissipation (T <sub>a</sub> =25°C)	625	mW
	Derate above 25°C	5.0	mW/°C
TJ	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	-55~150	°C
Rth(j-a)	Thermal Resistance, Junction to Ambient	200	°C/W

## **Electrical Characteristics** $T_a$ =25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	I <sub>C</sub> =100μA, I <sub>E</sub> =0	20			V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> =1mA, I <sub>B</sub> =0	15			V
BV <sub>CBO</sub>	Emitter-Base Breakdown Voltage	I <sub>E</sub> =10μA, I <sub>C</sub> =0	3.0			V
I <sub>CBO</sub>	Collector Cut-off Current	V <sub>CB</sub> =15V, I <sub>E</sub> =0			100	nA
h <sub>FE</sub>	DC Current Gain	V <sub>CE</sub> =10V, I <sub>C</sub> =5mA	25		250	
V <sub>CE</sub> (sat)	Collector Emitter Saturation Voltage	I <sub>C</sub> =10mA, I <sub>B</sub> =1mA			0.5	V
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> =10V, I <sub>C</sub> =5mA f=100MHz	800			MHz
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> =10V, I <sub>E</sub> =0, f=1MHz	0.3		0.9	pF
h <sub>fe</sub>	Small Signal Current Gain	V <sub>CE</sub> =10V, I <sub>C</sub> =5mA f=1KHz	30			
NF	Noise Figure	$V_{CC}$ =12V, $I_{C}$ =5mA $R_{S}$ =50 $\Omega$ , f=200MHz			6.0	dB
G <sub>PE</sub>	Amplifier Power Gain	$V_{CC}$ =12V, $I_{C}$ =5mA $R_{S}$ =50 $\Omega$ , f=200MHz		24		dB

# **Typical Characteristics**

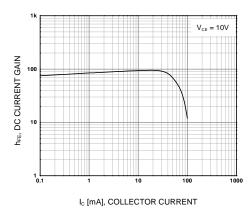


Figure 1. DC current Gain

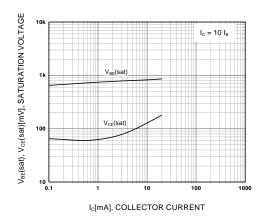


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

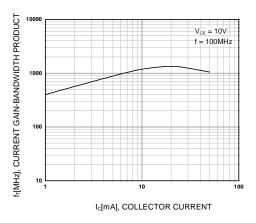
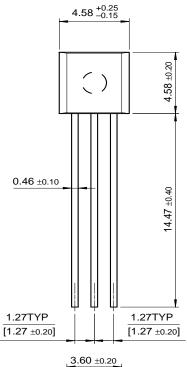
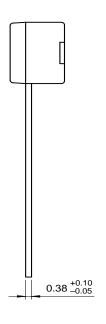


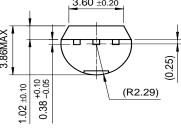
Figure 3. Current Gain Bandwidth Product

# **Package Demensions**

TO-92







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